

## PATENT ASSIGNMENT COVER SHEET

Electronic Version v1.1  
 Stylesheet Version v1.2

EPAS ID: PAT2848249

<b>SUBMISSION TYPE:</b>	NEW ASSIGNMENT
<b>NATURE OF CONVEYANCE:</b>	ASSIGNMENT
<b>CONVEYING PARTY DATA</b>	
<b>Name</b>	<b>Execution Date</b>
FRANÇOIS HÉBERT	03/31/2008
ANUP BHALLA	03/31/2008
<b>RECEIVING PARTY DATA</b>	
<b>Name:</b>	ALPHA & OMEGA SEMICONDUCTOR LTD
<b>Street Address:</b>	CANNON'S COURT 22, VICTORIA STREET
<b>City:</b>	HAMILTON
<b>State/Country:</b>	BERMUDA
<b>Postal Code:</b>	HM12
<b>PROPERTY NUMBERS Total: 1</b>	
<b>Property Type</b>	<b>Number</b>
<b>Application Number:</b>	14256843
<b>CORRESPONDENCE DATA</b>	
<b>Fax Number:</b>	(510)668-0239
<i>Correspondence will be sent to the e-mail address first; if that is unsuccessful, it will be sent via US Mail.</i>	
<b>Phone:</b>	510-668-0965
<b>Email:</b>	stephen@jdiipatent.com
<b>Correspondent Name:</b>	JOSHUA D. ISENBERG
<b>Address Line 1:</b>	JDI PATENT
<b>Address Line 2:</b>	809 CORPORATE WAY
<b>Address Line 4:</b>	FREMONT, CALIFORNIA 94539
<b>ATTORNEY DOCKET NUMBER:</b>	ANO-012/DIV2
<b>NAME OF SUBMITTER:</b>	JOSHUA D. ISENBERG
<b>SIGNATURE:</b>	/Joshua D. Isenberg, Reg. No. 41088/
<b>DATE SIGNED:</b>	05/08/2014
<b>Total Attachments: 2</b>	
source=ANO-012_DIV2_Assignment_for_filing#page1.tif	
source=ANO-012_DIV2_Assignment_for_filing#page2.tif	

## ASSIGNMENT

**INVENTOR  
AND CITY**

Whereas, I, **François Hébert** of 18 Melrose Court,  
San Mateo, CA 94402

have invented:

**TITLE:**

**IMPROVED SOURCE AND BODY CONTACT STRUCTURE FOR  
TRENCH-DMOS DEVICES USING POLYSILICON**

**DATE INVENTOR  
SIGNED THE  
DECLARATION**

and executed a United States patent application therefor

on March 31, 2008. Said assignor hereby authorize and request  
their attorney, Joshua D. Isenberg, of 809 Corporate Way, Fremont,  
California, to insert here in parentheses (Application number  
14/256,843, filed April 18, 2014) the filing  
date and application number of said application when known.

Whereas, **Alpha & Omega Semiconductor, LTD**, a Bermuda  
Company, having its registered address at Cannon's Court 22, Victoria  
Street, Hamilton HM12, Bermuda, (hereinafter called **AOS**), desires to  
acquire the entire right, title and interest of said application and invention,  
and to any United States and foreign patents to be obtained therefore;

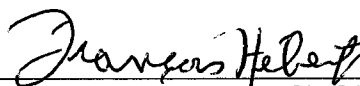
Now therefore for a valuable consideration, receipt whereof is  
hereby acknowledged, I, the above named, hereby sell, assign, and transfer  
to **AOS**, its successors and assigns, the entire right, title and interest in the  
said application and invention therein disclosed for the United States and  
foreign countries, and all rights of priority resulting from the filing said  
United States application, and I request the Commissioner of Patents to  
issue any Letters Patent granted upon the invention set forth in said  
application to **AOS** its successors and assigns; and I hereby agree that  
**AOS** may apply for foreign Letters Patent on said invention and I will  
execute all papers necessary in connection with the United States and  
foreign applications when called upon to do so by **AOS** its successors and  
assigns.

**CITY AND**

Signed and Sealed at Sunnyvale, CA

**DATE**

on March 31, 2008



SIGNATURE OF INVENTOR

## ASSIGNMENT

**INVENTOR  
AND CITY**

Whereas, I, **Anup Bhalla** of 1406 Block Drive  
Santa Clara, California 95050

have invented:

**TITLE:**

**IMPROVED SOURCE AND BODY CONTACT STRUCTURE FOR  
TRENCH-DMOS DEVICES USING POLYSILICON**

**DATE INVENTOR  
SIGNED THE  
DECLARATION**

and executed a United States patent application therefor

on 3/31/, 2008. Said assignor hereby authorize and request  
their attorney, Joshua D. Isenberg, of 809 Corporate Way, Fremont,  
California, to insert here in parentheses (Application number  
14/256,843, filed April 18, 2014) the filing  
date and application number of said application when known.

Whereas, **Alpha & Omega Semiconductor, LTD**, a Bermuda  
Company, having its registered address at Cannon's Court 22, Victoria  
Street, Hamilton HM12, Bermuda, (hereinafter called **AOS**), desires to  
acquire the entire right, title and interest of said application and invention,  
and to any United States and foreign patents to be obtained therefore;

Now therefore for a valuable consideration, receipt whereof is  
hereby acknowledged, I, the above named, hereby sell, assign, and transfer  
to **AOS**, its successors and assigns, the entire right, title and interest in the  
said application and invention therein disclosed for the United States and  
foreign countries, and all rights of priority resulting from the filing said  
United States application, and I request the Commissioner of Patents to  
issue any Letters Patent granted upon the invention set forth in said  
application to **AOS** its successors and assigns; and I hereby agree that  
**AOS** may apply for foreign Letters Patent on said invention and I will  
execute all papers necessary in connection with the United States and  
foreign applications when called upon to do so by **AOS** its successors and  
assigns.

**CITY AND**

Signed and Sealed at Sunnyvale, CA

**DATE**

on 3/31/, 2008

  
SIGNATURE OF INVENTOR